

G3VM-353B/E

MOS FET Relays

DIP 6-pin package, Analog-switching
MOS FET Relays with SPST-NC Contact.

RoHS compliant

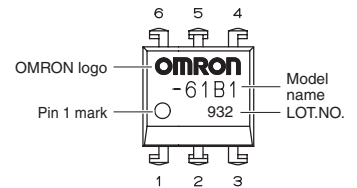
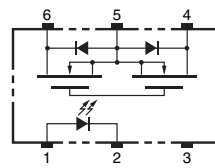


Note: The actual product is marked differently from the image shown here.

Application Examples

- Communication equipment
- Security systems
- FA systems
- Test & Measurement equipment

Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
DIP6	1b (SPST-NC)	PCB Terminals	350 V	G3VM-353B	50	-
		Surface-mounting Terminals		G3VM-353E		
				G3VM-353E (TR)	-	1,500

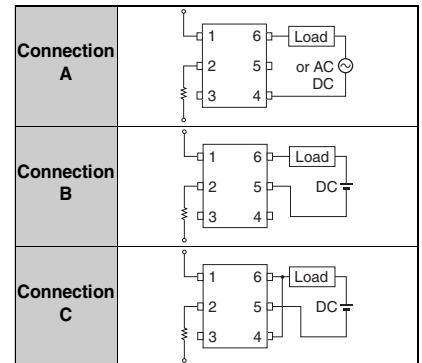
* The AC peak and DC value are given for the load voltage.

Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	I_F	50	mA	
	Repetitive peak LED forward current	I_{FP}	1	A	100 μ s pulses, 100 pps
	LED forward current reduction rate	$\Delta I_F / ^\circ C$	-0.5	mA/ $^\circ C$	Ta $\geq 25^\circ C$
	LED reverse voltage	V_R	5	V	
Connection temperature		T_J	125	$^\circ C$	
Load voltage (AC peak/DC)		V_{OFF}	350	V	
Output	Continuous load current	Connection A	150	mA	Connection A: AC peak/DC Connection B and C: DC
		Connection B	150		
		Connection C	300		
	ON current reduction rate	$\Delta I_o / ^\circ C$	-1.5	mA/ $^\circ C$	Ta $\geq 25^\circ C$
Connection temperature		T_J	125	$^\circ C$	
Dielectric strength between I/O (See note 1.)		V_{I-O}	2500	Vrms	AC for 1 min
Ambient operating temperature		Ta	-40 to +85	$^\circ C$	With no icing or condensation
Ambient storage temperature		Tstg	-55 to +125	$^\circ C$	With no icing or condensation
Soldering temperature		-	260	$^\circ C$	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

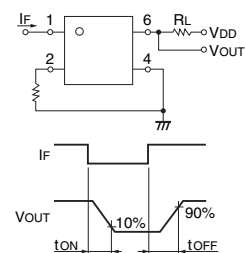
Connection Diagram



Electrical Characteristics (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	V_F	1.0	1.15	1.3	V	$I_F = 10$ mA
	Reverse current	I_R	-	-	10	μA	$V_R = 5$ V
	Capacity between terminals	C_T	-	30	-	pF	$V = 0, f = 1$ MHz
Trigger LED forward current		I_{FC}	-	1	3	mA	$I_{OFF} = 10$ μA
Output	Maximum resistance with output ON	Connection A	-	15	25	Ω	$I_o = 150$ mA
		Connection B	-	8	14	Ω	$I_o = 150$ mA
		Connection C	-	4	7	Ω	$I_o = 300$ mA
Current leakage when the relay is open		I_{LEAK}	-	-	1.0	μA	$I_F = 5$ mA, $V_{OFF} = 350$ V
Capacity between terminals		C_{OFF}	-	85	-	pF	$V = 0, f = 1$ MHz, $I_F = 5$ mA
Capacity between I/O terminals		C_{I-O}	-	0.8	-	pF	$f = 1$ MHz, $V_s = 0$ V
Insulation resistance between I/O terminals		R_{I-O}	1000	-	-	M Ω	$V_{I-O} = 500$ VDC, $R_oH \leq 60\%$
Turn-ON time		t_{ON}	-	0.1	1.0	ms	$I_F = 5$ mA, $R_L = 200$ Ω , $V_{DD} = 20$ V (See note 2.)
Turn-OFF time		t_{OFF}	-	1.0	3.0	ms	

Note: 2. Turn-ON and Turn-OFF Times



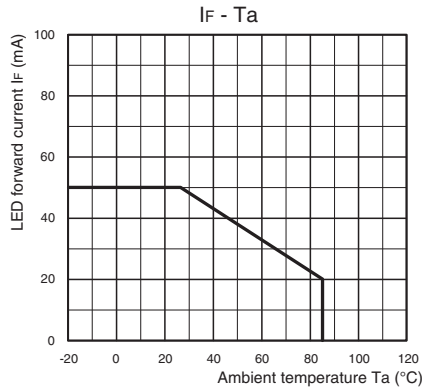
Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

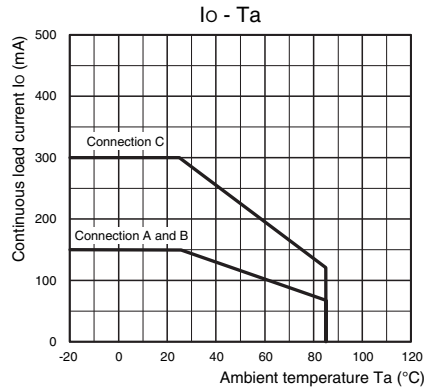
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	-	-	280	V
Operating LED forward current	I_F	5	-	25	mA
Continuous load current (AC peak/DC)	I_o	-	-	150	mA
Ambient operating temperature	T_a	-20	-	65	°C

Engineering Data

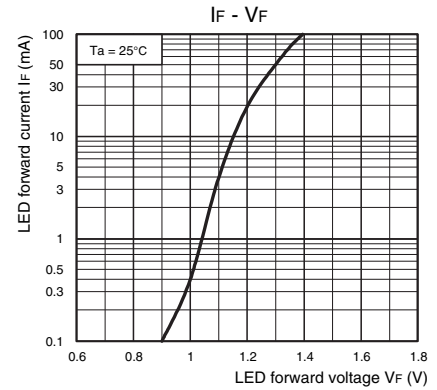
LED forward current vs. Ambient temperature



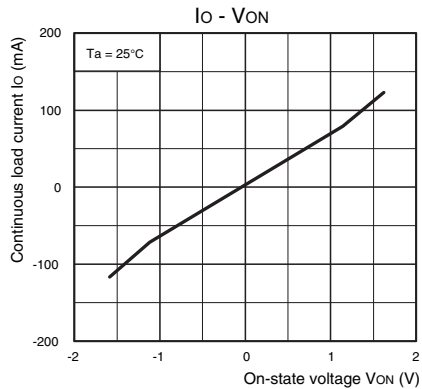
Continuous load current vs. Ambient temperature



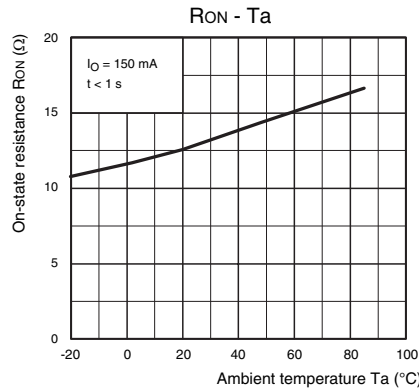
LED forward current vs. LED forward voltage



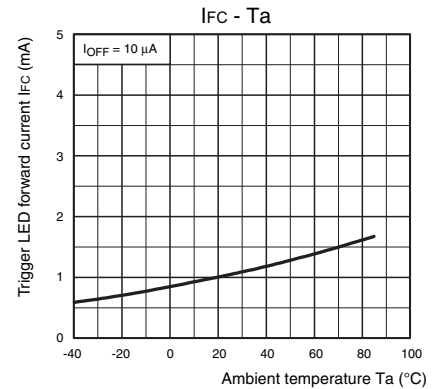
Continuous load current vs. On-state voltage



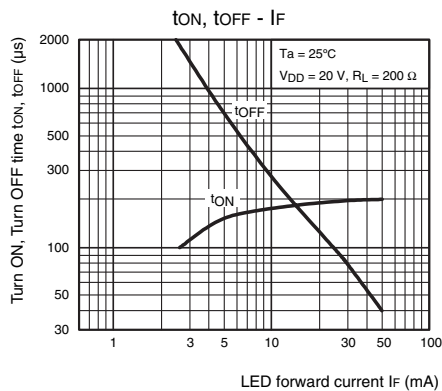
On-state resistance vs. Ambient temperature



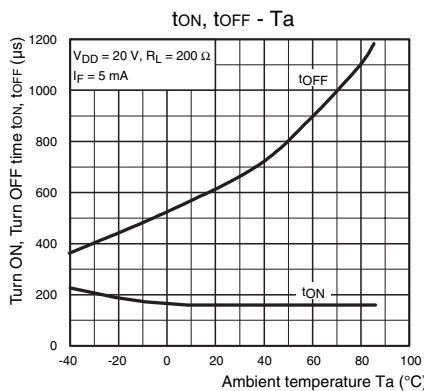
Trigger LED forward current vs. Ambient temperature



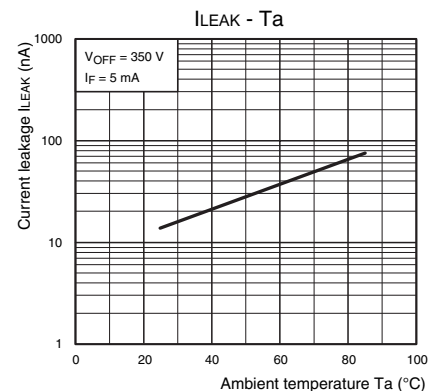
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature



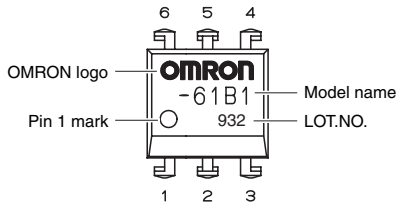
Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

■ Appearance

DIP (Dual Inline Package)

DIP6



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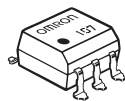
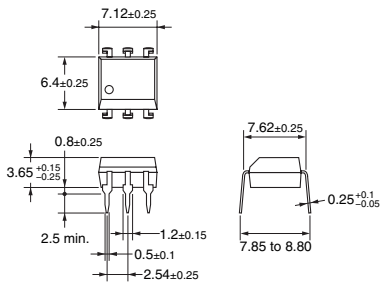
■ Dimensions

(Unit: mm)



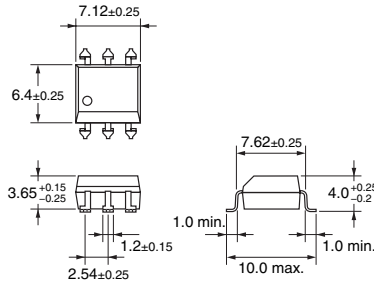
PCB Terminals

Weight: 0.4 g

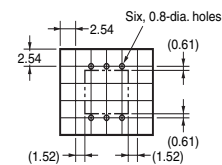


Surface-mounting Terminals

Weight: 0.4 g

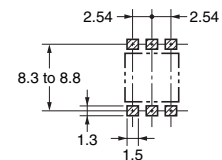


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



Note: The actual product is marked differently from the image shown here.

- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

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